



C Series Open Mode Design

Type: C2012 [EIA CC0805]

C3216 [EIA CC1206] C3225 [EIA CC1210] C4532 [EIA CC1812] C5750 [EIA CC2220]

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TDK MLCC US Catalog



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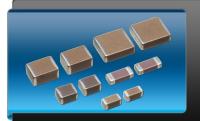
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C Series

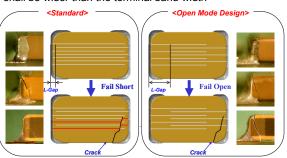
Open Mode Design

Type: C2012, C3216, C3225, C4532, C5750

Features



- · Increase resistance to mechanical bending, temperature cycle, vibration, and electrical stresses
- · Available in X7R and X8R dielectrics
- · When a chip capacitor is cracked by mechanical stress such as board bending, open mode construction helps user reduce the risk of short circuits
- The Open Mode design defines that the L-Gap length shall be wider than the terminal band width



 The Open Mode concept does not guaranteed MLCC will always fail open. This design is intended to reduce the risk of the MLCC failing short. All MLCC caution guidelines apply.

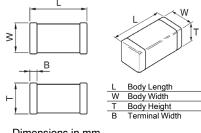
Applications



- · Automotive and other high stress applications
- · Battery line circuits with high board flex stress

Shape & **Dimensions**





Dimensions in mm



Series Name

Symbol	Design
5	Open Mode

Dimensions L x W (mm)

Case Code	Length	Width
C2012	2.00 ± 0.20	1.25 ± 0.20
C3216	3.20 ± 0.20	1.60 ± 0.20
C3225	3.20 ± 0.40	2.50 ± 0.30
C4532	4.50 ± 0.40	3.20 ± 0.40
C5750	5.70 ± 0.40	5.00 ± 0.40

Temperature Characteristic

Temperature Characteristics	Capacitance Change	Temperature Range
X7R	±15%	-55 to +125°C
X8R	±15%	-55 to +150°C

Rated Voltage (DC)

Voltage Code	Voltage (DC)
1C	16V
1E	25V
1H	50V
2A	100V
2E	250V
21	630\/

Internal Codes

rermination Code	Style
5xxx	Open Mode Design
Packaging Style	
Packaging Code	Style
Т	Tape & Reel
Capacitance Tolera	ance
Tolerance Code	Tolerance
K	± 10%
M	± 20%

Nominal Capacitance (pF)

The capacitance is expressed in three digit codes and in units of pico Farads (pF). The first and second digits identify the first and second significant figures of the capacitance. The third digit identifies the multiplier. R designates a decimal point.

Capacitance Code	Capacitance
0R5	0.5pF
010	1pF
102	1,000pF (1nF)
105	1,000,000pF (1µF)

3216 X7R 2A 105 K T 5XXX





C2012 [EIA CC0805]

Capacitance Range Chart

Temperature Characteristics: X7R, (± 15%), X8R (± 15%) Rated Voltage: 250V (2E), 100V (2A), 50V (1H)

- Hatou voltag	Tated Voltage. 2007 (2L), 1007 (2N), 007 (11)								
Consoltones	Con			X7R					
Capacitance (pF)	Cap Code	Tolerance	2E (250V)	2A (100V)	1H (50V)	1H (50V)			
1,000	102	K: ± 10%							
1,500	152								
2,200	222								
3,300	332								
4,700	472								
6,800	682								
10,000	103								
15,000	153								
22,000	223								
33,000	333								
47,000	473								
68,000	683								
100,000	104								





C2012 [EIA CC0805]

Class 2 (Temperature Stable)

Temperature Characteristics X7R (-55 to +125°C, ±15%), X8R (-55 to +150°C, ±15%)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C2012X7R1H104KT5	X7R	50V	100,000	± 10%	1.25 ± 0.20
C2012X7R2A102KT5	X7R	100V	1,000	± 10%	0.85 ± 0.10
C2012X7R2A152KT5	X7R	100V	1,500	± 10%	0.85 ± 0.10
C2012X7R2A222KT5	X7R	100V	2,200	± 10%	0.85 ± 0.10
C2012X7R2A332KT5	X7R	100V	3,300	± 10%	0.85 ± 0.10
C2012X7R2A472KT5	X7R	100V	4,700	± 10%	0.85 ± 0.10
C2012X7R2A682KT5	X7R	100V	6,800	± 10%	0.85 ± 0.10
C2012X7R2A103KT5	X7R	100V	10,000	± 10%	0.85 ± 0.10
C2012X7R2A153KT5	X7R	100V	15,000	± 10%	1.25 ± 0.20
C2012X7R2A223KT5	X7R	100V	22,000	± 10%	1.25 ± 0.20
C2012X7R2E102KT5	X7R	250V	1,000	± 10%	0.85 ± 0.10
C2012X7R2E152KT5	X7R	250V	1,500	± 10%	0.85 ± 0.10
C2012X7R2E222KT5	X7R	250V	2,200	± 10%	0.85 ± 0.10
C2012X7R2E332KT5	X7R	250V	3,300	± 10%	0.85 ± 0.10
C2012X7R2E472KT5	X7R	250V	4,700	± 10%	0.85 ± 0.10
C2012X7R2E682KT5	X7R	250V	6,800	± 10%	1.25 ± 0.20
C2012X7R2E103KT5	X7R	250V	10,000	± 10%	1.25 ± 0.20
C2012X7R2E153KT5	X7R	250V	15,000	± 10%	1.25 ± 0.20
C2012X8R1H223KT5	X8R	50V	22,000	± 10%	0.85 ± 0.10
C2012X8R1H333KT5	X8R	50V	33,000	± 10%	0.85 ± 0.10
C2012X8R1H473KT5	X8R	50V	47,000	± 10%	1.25 ± 0.20
C2012X8R1H683KT5	X8R	50V	68,000	± 10%	1.25 ± 0.20





C3216 [EIA CC1206]

Capacitance Range Chart

Temperature Characteristics: X7R, (± 15%)

Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 16V (1C)

Consoitance	Con			X	7R		
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1C (16V)	
1,000	102	K: ± 10%					1
1,500	152						
2,200	222						
3,300	332						
4,700	472						
6,800	682						
10,000	103						
15,000	153						
22,000	223						
33,000	333						
47,000	473						Stan
68,000	683						
100,000	104						
150,000	154						
1,000,000	105						
4,700,000	475						_





Capacitance Range Table

C3216 [EIA CC1206]

Class 2 (Temperature Stable)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C3216X7R1C475MT5	X7R	16V	4,700,000	± 20%	1.60 ± 0.30
C3216X7R2A333KT5	X7R	100V	33,000	± 10%	1.15 ± 0.10
C3216X7R2A473KT5	X7R	100V	47,000	± 10%	1.15 ± 0.10
C3216X7R2A683KT5	X7R	100V	68,000	± 10%	1.60 ± 0.30
C3216X7R2A104KT5	X7R	100V	100,000	± 10%	1.60 ± 0.30
C3216X7R2A154KT5	X7R	100V	150,000	± 10%	1.60 ± 0.30
C3216X7R2A105KT5	X7R	100V	1,000,000	± 10%	1.60 ± 0.30
C3216X7R2E153KT5	X7R	250V	15,000	± 10%	1.15 ± 0.10
C3216X7R2E223KT5	X7R	250V	22,000	± 10%	1.15 ± 0.10
C3216X7R2E333KT5	X7R	250V	33,000	± 10%	1.60 ± 0.30
C3216X7R2E473KT5	X7R	250V	47,000	± 10%	1.60 ± 0.30
C3216X7R2E683KT5	X7R	250V	68,000	± 10%	1.60 ± 0.30
C3216X7R2E104KT5	X7R	250V	100,000	± 10%	1.60 ± 0.30
C3216X7R2J102KT5	X7R	630V	1,000	± 10%	1.15 ± 0.10
C3216X7R2J152KT5	X7R	630V	1,500	± 10%	1.15 ± 0.10
C3216X7R2J222KT5	X7R	630V	2,200	± 10%	1.15 ± 0.10
C3216X7R2J332KT5	X7R	630V	3,300	± 10%	1.15 ± 0.10
C3216X7R2J472KT5	X7R	630V	4,700	± 10%	1.15 ± 0.10
C3216X7R2J682KT5	X7R	630V	6,800	± 10%	1.15 ± 0.10
C3216X7R2J103KT5	X7R	630V	10,000	± 10%	1.15 ± 0.10
C3216X7R2J153KT5	X7R	630V	15,000	± 10%	1.30 ± 0.15
C3216X7R2J223KT5	X7R	630V	22,000	± 10%	1.30 ± 0.15
C3216X7R2J333KT5	X7R	630V	33,000	± 10%	1.60 ± 0.30





C3225 [EIA CC1210]

Capacitance Range Chart

Temperature Characteristics: X7R, (± 15%)

Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

		(==), ==== (==)	, (.,,	// == · (· =	,,	,		-
Consoltones	Con				X	7R			
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	
47,000	473	K: ± 10%							
68,000	683								
100,000	104								
150,000	154								
220,000	224								
330,000	334								Standard Thickness
470,000	474								
680,000	684								1.15 mm
1,000,000	105								1.60 mm
1,500,000	155								2.00 mm
2,200,000	225								2.30 mm
3,300,000	335								
4.700.000	475								2.50 mm

Capacitance Range Table

C3225 [EIA CC1210]

Class 2 (Temperature Stable)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C3225X7R1C335KT5	X7R	16V	3,300,000	± 10%	2.00 ± 0.20
C3225X7R1C475KT5	X7R	16V	4,700,000	± 10%	2.50 ± 0.30
C3225X7R1E105KT5	X7R	25V	1,000,000	± 10%	1.15 ± 0.10
C3225X7R1E155KT5	X7R	25V	1,500,000	± 10%	1.60 ± 0.30
C3225X7R1E225KT5	X7R	25V	2,200,000	± 10%	2.00 ± 0.20
C3225X7R1H474KT5	X7R	50V	470,000	± 10%	1.60 ± 0.30
C3225X7R1H684KT5	X7R	50V	680,000	± 10%	2.00 ± 0.20
C3225X7R2A334KT5	X7R	100V	330,000	± 10%	2.00 ± 0.20
C3225X7R2A105KT5	X7R	100V	1,000,000	± 10%	2.00 ± 0.20
C3225X7R2A225KT5	X7R	100V	2,200,000	± 10%	2.30 ± 0.20
C3225X7R2E104KT5	X7R	250V	100,000	± 10%	2.00 ± 0.20
C3225X7R2E154KT5	X7R	250V	150,000	± 10%	2.00 ± 0.20
C3225X7R2E224KT5	X7R	250V	220,000	± 10%	2.00 ± 0.20
C3225X7R2J473KT5	X7R	630V	47,000	± 10%	2.00 ± 0.20
C3225X7R2J683KT5	X7R	630V	68,000	± 10%	2.00 ± 0.20





C4532 [EIA CC1812]

Capacitance Range Chart

Temperature Characteristics: X7R, (± 15%)

Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

Trated Voltag	e. 000 v	(ZU), ZUUV (ZL)	, 100V (ZA), 50 v (ii i	1), 200 (12), 10 v (10)		_
Consoltones	Con	_			X	7R			
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	
68,000	683	K: ± 10%							
100,000	104								
150,000	154								
220,000	224								
330,000	334								
470,000	474								
680,000	684								
1,000,000	105								
1,500,000	155								Standard Thickness
3,300,000	335								1.60 mm
4,700,000	475								2.00 mm
6,800,000	685								
10,000,000	106								2.30 mm



C4532 [EIA CC1812]

Class 2 (Temperature Stable)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C4532X7R1C685KT5	X7R	16V	6,800,000	± 10%	2.00 ± 0.20
C4532X7R1C106KT5	X7R	16V	10,000,000	± 10%	2.30 ± 0.20
C4532X7R1E335KT5	X7R	25V	3,300,000	± 10%	1.60 ± 0.30
C4532X7R1E475KT5	X7R	25V	4,700,000	± 10%	2.00 ± 0.20
C4532X7R1H105KT5	X7R	50V	1,000,000	± 10%	1.60 ± 0.30
C4532X7R1H155KT5	X7R	50V	1,500,000	± 10%	2.30 ± 0.20
C4532X7R2A684KT5	X7R	100V	680,000	± 10%	2.30 ± 0.20
C4532X7R2E154KT5	X7R	250V	150,000	± 10%	1.60 ± 0.30
C4532X7R2E224KT5	X7R	250V	220,000	± 10%	2.30 ± 0.20
C4532X7R2E334KT5	X7R	250V	330,000	± 10%	2.30 ± 0.20
C4532X7R2E474KT5	X7R	250V	470,000	± 10%	2.30 ± 0.20
C4532X7R2J683KT5	X7R	630V	68,000	± 10%	1.60 ± 0.30
C4532X7R2J104KT5	X7R	630V	100,000	± 10%	2.30 ± 0.20





C5750 [EIA CC2220]

Capacitance Range Chart

Temperature Characteristics: X7R, (± 15%)

Rated Voltage: 630V (2J), 250V (2E), 100V (2A), 50V (1H), 25V (1E), 16V (1C)

Tiatoa voitag	0. 000 V	(20), 200 v (2L),	, 1001 (27)	.), OOV (111	1), 201 (12), 10 v (10	,		_
0	0			X7R					
Capacitance (pF)	Cap Code	Tolerance	2J (630V)	2E (250V)	2A (100V)	1H (50V)	1E (25V)	1C (16V)	
150,000	154	K: ± 10%							
220,000	224								
330,000	334								
470,000	474								
680,000	684								
1,000,000	105								
1,500,000	155								
2,200,000	225								Standard Thickness
3,300,000	335								
4,700,000	475								1.60 mm
6,800,000	685								2.00 mm
10,000,000	106								2.30 mm
15,000,000	156								2.80 mm
22.000.000	226								2.00 11111



C5750 [EIA CC2220]

Class 2 (Temperature Stable)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C5750X7R1C226MT5	X7R	16V	22,000,000	± 20%	2.80 ± 0.20
C5750X7R1E685KT5	X7R	25V	6,800,000	± 10%	1.60 ± 0.30
C5750X7R1E106KT5	X7R	25V	10,000,000	± 10%	2.00 ± 0.20
C5750X7R1E156MT5	X7R	25V	15,000,000	± 20%	2.80 ± 0.20
C5750X7R1H225KT5	X7R	50V	2,200,000	± 10%	1.60 ± 0.30
C5750X7R1H335KT5	X7R	50V	3,300,000	± 10%	2.30 ± 0.20
C5750X7R1H475KT5	X7R	50V	4,700,000	± 10%	2.80 ± 0.20
C5750X7R2A684KT5	X7R	100V	680,000	± 10%	1.60 ± 0.30
C5750X7R2A105KT5	X7R	100V	1,000,000	± 10%	2.30 ± 0.20
C5750X7R2A155KT5	X7R	100V	1,500,000	± 10%	2.30 ± 0.20
C5750X7R2E334KT5	X7R	250V	330,000	± 10%	1.60 ± 0.30
C5750X7R2E474KT5	X7R	250V	470,000	± 10%	2.30 ± 0.20
C5750X7R2E684KT5	X7R	250V	680,000	± 10%	2.30 ± 0.20
C5750X7R2E105KT5	X7R	250V	1,000,000	± 10%	2.30 ± 0.20
C5750X7R2J154KT5	X7R	630V	150,000	± 10%	1.60 ± 0.30
C5750X7R2J224KT5	X7R	630V	220,000	± 10%	2.30 ± 0.20



C Series – Open Mode Design

Unit: mm

No.	Item	Performance			Test or Inspection Method				
1	External Appearance		defects which may af ormance.	fect	Inspect v	nspect with magnifying glass (3 $ imes$).			
2	Insulation Resistance	whice cap	10,000MΩ or 500MΩ•μF min., whichever smaller. (As for the capacitors of rated voltage 16V DC, 10,000 MΩ or 100MΩ•μF min.,)			Apply rated voltage for 60s. As for the rated voltage 630V DC, apply 500V DC.			
3	Voltage Proof	With	nstand test voltage wi	ithout	Rate	ed Voltage	Apply volta	age	
		insu	ılation breakdown or	other damage.	R'	V ≤ 100V	2.5 × rated vo	oltage	
					R	V > 100V	1.5 × rated vo	oltage	
							be applied for not exceed 50n	1 to 5s. Charge / nA.	
4	Capacitance	With	Within the specified tolerance.			Rated Capacitance	Measuring Frequency	Measuring voltage	
			Class 2	C ≤ 10uF	1kHz±10%	1.0±0.2V _{rms}			
						C > 10uF	120Hz±20%	0.5±0.2 V _{rms}	
5	Dissipation	T.C.	T.C. Rated Voltage (DC) D.F. X7R RV = 25V& 50V 3% max.		See No.	See No.4 in this table for measuring condition.			
	Factor	X7R							
-	(Class 2)	X8R	RV ≤ 16V	5% max.					
6	Temperature	Cap	Capacitance Change (%) No Voltage Applied X7R: ± 15%			Capacitance shall be measured by the steps shown in the following table after thermal equilibrium is obtained for each step.			
	Characteristics								
	of Capacitance (Class 2)	_				ΔC be calculated ref. STEP 3 reading			
	(01035 2)		X8R: ± 15%		Step Temperature (°C)			-	
					1				
					2	Min. operating temp. ± 2			
					3	Reference temp		-	
					4	Max. operating	temp. ± 2	-	
7	Robustness of Terminations	brea	No sign of termination coming off, breakage of ceramic, or other abnormal signs.				citors on P.C. be lix 1b) and appl		
							Pushing f		
8	Bending	Noı	mechanical damage.			older the capac x 2) and bend i	citor on P.C. bo t for 1mm.	ard (shown in	





C Series – Open Mode Design

No.	ltem	Performance		Test or Inspection Method		
9	Solderability	New solder to co termination.	ver over 75% of	Completely soak both terminations in solder at 235 \pm 5°C for 2 \pm 0.5s.		
			inholes or rough spots	Solder: H63A (JIS Z 3282)		
		but not concentra	ated in one spot.	Flux: Isopropyl alcohol (JIS K 8839)		
		Ceramic surface not be exposed of shifting of termina		Rosin (JIS K 5902) 25% solid solution.		
			A section			
10	0 Resistance to solder heat			Completely soak both terminations in solder at 260±5°C for 5±1s.		
	External		owed and terminations			
	appearance	shall be covered solder.	at least 60% with new	Preheating condition		
-		<u> </u>		Temp.: 150±10°C Time : 1 to 2min.		
	Capacitance	Characteristics Change from the value before test		Flux: Isopropyl alcohol (JIS K 8839)		
		Olassa O X7R		Rosin (JIS K 5902) 25% solid solution.		
		Class 2 X8R ± 7.5%		Solder: H63A (JIS Z 3282)		
	D.F. (Class 2)	Meet the initial sp	pec.	Leave the capacitor in ambient conditions for 6 to 24h		
	Insulation Resistance	Meet the initial sp	pec.	before measurement.		
	Voltage Proof	No insulation bre damage.	akdown or other	_		
11	Vibration			Reflow solder the capacitor on P.C. board (shown in		
	External No mechanical damage. appearance		amage.	Appendix 1a or Appendix 1b) before testing. Vibrate the capacitor with amplitude of 1.5mm P-P		
	Capacitance	Characteristics	Change from the value before test	 sweeping the frequencies from 10Hz to 55Hz and bacto 10Hz after 1min. 		
		Class 2 X7R X8R	± 7.5%	Repeat this for 2h each in 3 perpendicular directions.		
	D.F. (Class 2) Meet the initial spec.		Dec.	-		





C Series – Open Mode Design

No.	Item	Performance		Test o	r Inspection Method			
12	Temperature cycle External No mechanical damage. appearance Capacitance Characteristics Change from the value before test		damage.	Reflow solder the capacitors on a P.C. board (shown in Appendix 1a or Appendix 1b) before testing. Expose the capacitor in the conditions in step 1				
			Leave t	through step 4, and repeat 5 times consecutively. Leave the capacitor in ambient conditions for 24±2h before measurement.				
		Class 2 X8R	± 7.5%	Step	Temperature (°C)	Time (min.)		
	D.F. (Class 2)	Meet the initial s	Meet the initial spec.		Min. operating temp. ±3 Reference Temp.	30 ± 3 2 – 5		
	Insulation Meet the initial spec. Resistance Voltage No insulation breakdown or other damage.		2	Max. operating temp. \pm 2	30 ± 2			
			4	Reference Temp.	2 - 5			
13	Moisture Resista	istance (Steady State)			Reflow solder the capacitor on P.C. board (shown in			
	External appearance	No mechanical	damage.	Leave a	Appendix 1a or Appendix 1b) before testing. Leave at temperature 40±2°C, 90 to 95%RH for 500 +24,0h. Leave the capacitor in ambient condition for 24±2h			
	Capacitance	Characteristics	Change from the value before test					
		Class 2 X7R X8R	± 12.5%	before r	neasurement.			
	D.F. (Class 2)	Characteristics X7R: 200% of ir X8R: 200% of ir	•					
	Insulation Resistance	smaller. (As for	$M\Omega$ •μF min., whichever the capacitors of rated , 1,000 M Ω or 10M Ω •μF					





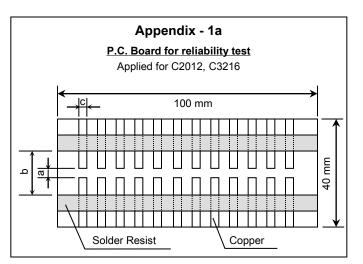
C Series – Open Mode Design

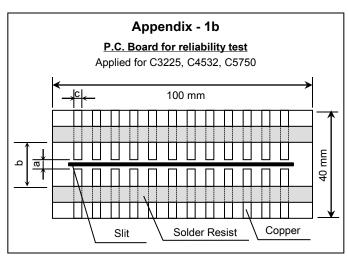
No.	Item	Performa	nce		Test or Inspection Method		
14	Moisture Resista	ance			Reflow solder the capacitors on P.C. board (shown in Appendix 1a or Appendix 1b) before testing.		
	External appearance	No mechar	No mechanical damage.		Apply the rated voltage at temperature 40±2°C and 90 to 95%RH for 500 +24,0h.		
	Capacitance	Character	ristics	Change from the value before test	Charge/discharge current shall not exceed 50mA.		
		Class 2	llass 2 X7R ± 12.5%		Leave the capacitor in ambient conditions for $24\pm2\text{h}$ before measurement.		
	D.F. (Class 2)	Characteris	stics		Voltage conditioning:		
			X7R: 200% of initial spec. max. X8R: 200% of initial spec. max. 500MΩ or 25MΩ•μF min., whichever smaller. (As for the capacitors of rated		Voltage treat the capacitors under testing temperature and voltage for 1 hour.		
	Insulation				Leave the capacitors in ambient condition for $24\pm2h$ before measurement.		
	Resistance	Resistance smaller. (As for the capacitors of rated voltage 16V DC, 500 M Ω or 5M Ω • μ F min.,)			Use this measurement for initial value.		
15	Life				Reflow solder the capacitors on P.C. board (shown in Appendix 1a or Appendix 1b) before testing.		
	External	No mechar	nical da	amage.			
	appearance	-			Apply rated voltage at maximum operating temperature $\pm 2^{\circ}$ C for 1,000 +48, 0h. Some items may be tested at		
	Capacitance	Character	ristics	Change from the value before test	higher voltage (1.2x, 1.5x or 2xRV).		
		Clace 2	X7R X8R	± 15%	Charge/discharge current shall not exceed 50mA.		
	D.F. (Olassia)				Leave the capacitor in ambient conditions for 24±2h before measurement.		
	D.F. (Class 2) Characteristics X7R: 200% of initial spec. max. X8R: 200% of initial spec. max.		tial snec may	Voltage conditioning:			
			•	Voltage treat the capacitors under testing temperature			
	Insulation			•	and voltage for 1 hour.		
	Insulation 1,000M Ω or 50M Ω •μF min., whichever smaller. (As for the capacitors of rated voltage 16V DC, 1,000 M Ω or 10M Ω •μF		Leave the capacitors in ambient condition for $24\pm2h$ before measurement.				
		min.,)			Use this measurement for initial value.		

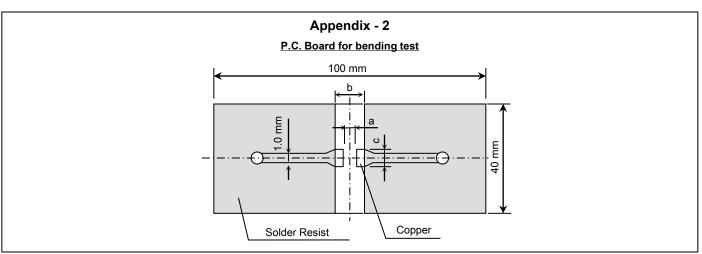
^{*}As for the initial measurement of capacitors (Class 2) on number 6, 10, 11, 12 and 13, leave capacitor at 150 -10, 0°C for 1 hour and measure the value after leaving capacitor for 24±2h in ambient condition.



C Series – Open Mode Design







Material: Glass Epoxy (As per JIS C6484 GE4)

P.C. Board thickness: 1.6mm

Copper (thickness 0.035mm)
Solder resist

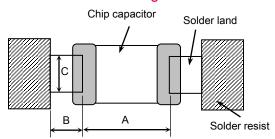
Case	Code	Dii	mensions (m	m)
JIS	EIA	а	b	С
C2012	CC0805	1.2	4.0	1.65
C3216	CC1206	2.2	5.0	2.0
C3225	CC1210	2.2	5.0	2.9
C4532	CC1812	3.5	7.0	3.7
C5750	CC2220	4.5	8.0	5.6





C Series – Open Mode Design

Recommended Soldering Land Pattern

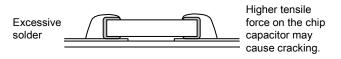


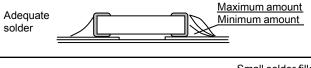
Wave Solderi	Unit: mm	
Туре	C2012	C3216
Symbol	[CC0805]	[CC1206]
Α	1.0 - 1.3	2.1 - 2.5
В	1.0 - 1.2	1.1 - 1.3
С	0.8 - 1.1	1.0 - 1.3

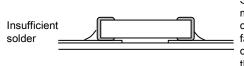
Reflow Solde	Unit: mm		
Туре	C2012	C3216 [CC1206]	
Symbol	[CC0805]		
Α	0.9 - 1.2	2.0 - 2.4	
В	0.7 - 0.9	1.0 - 1.2	
С	0.9 - 1.2	1.1 - 1.6	

Reflow Solde	Unit: mm		
Туре	C3225	C4532	C5750
Symbol	[CC1210]	[CC1812]	[CC2220]
Α	2.0 - 2.4	3.1 - 3.7	4.1 - 4.8
В	1.0 - 1.2	1.2 - 1.4	1.2 - 1.4
С	1.9 - 2.5	2.4 - 3.2	4.0 - 5.0

• Recommended Solder Amount

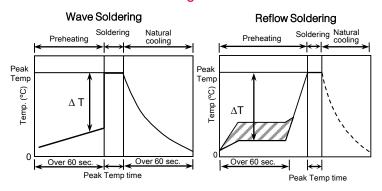


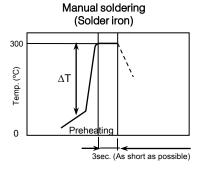




Small solder fillet may cause contact failure or failure to hold the chip capacitor to the P.C. board.

Recommended Soldering Profile





Recommended soldering duration

Tem		Wave S	oldering	Reflow Soldering		
	Dura.	Peak temp	Duration	Peak temp	Duration	
	Solder	(°C)	(sec.)	(°C)	(sec.)	
	Sn-Pb Solder	250 max.	3 max.	230 max.	20 max.	
	Lead-Free Solder	260 max.	5 max.	260 max.	10 max.	

Recommended solder compositions

Sn-37Pb (Sn-Pb solder)

Sn-3.0Ag-0.5Cu (Lead Free Solder)

Preheating Condition

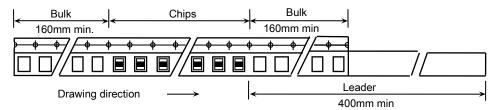
Soldering	Case Size - JIS (EIA)	Temp. (°C)
Wave soldering	C2012(CC0805), C3216(CC1206)	ΔT ≤ 150
Reflow soldering	C2012(CC0805), C3216(CC1206)	ΔT ≤ 150
	C3225(CC1210), C4532(CC1812), C5750(CC2220)	ΔT ≤ 130
Manual soldering	C2012(CC0805), C3216(CC1206)	ΔT ≤ 150
	C3225(CC1210), C4532(CC1812), C5750(CC2220)	ΔT ≤ 130



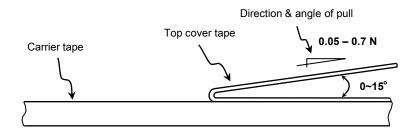


C Series – Open Mode Design

Carrier Tape Configuration

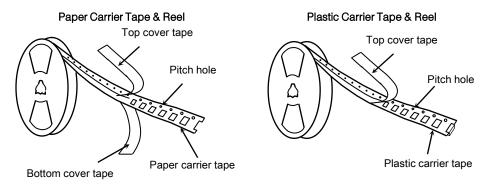


Peel Back Force (Top Tape)



- Carrier tape shall be flexible enough to be wound around a minimum radius of 30mm with components in tape.
- The missing of components shall be less than 0.1%
- Components shall not stick to the cover tape.
- The cover tape shall not protrude beyond the edges of the carrier tape and shall not cover the sprocket holes.

Chip Quantity Per Reel and Structure of Reel (Paper & Plastic)

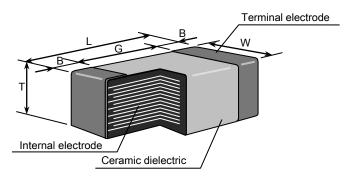


Case Code		Chip	Taning Material	Chip quantity (pcs.)		
JIS	EIA	Thickness	Taping Material	φ178mm (7") reel	φ330mm (13") reel	
C2012	CC0805	0.85 mm	Paper/Plastic	4,000	10,000	
02012	CC0803	1.25 mm	Plastic 2,000		10,000	
		1.15 mm	Plastic	2,000	10,000	
C3216	CC1206	1.30 mm				
		1.60 mm			8,000	
		1.15 mm	Plastic	2.000	10,000	
		1.60 mm		2,000	8,000	
C3225	CC1210	2.00 mm				
		2.30 mm		1,000	5,000	
		2.50 mm				
	CC1812	1.60 mm	Plastic	1,000	3,000	
C4532		2.00 mm				
		2.30 mm		500		
	:5750 CC2220	1.60 mm	Plastic	1,000		
C5750		2.00 mm		n Blootie		3,000
C3/30		2.30 mm		500		
		2.80 mm			2,000	



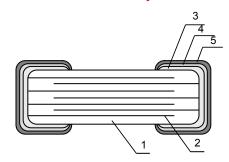
C Series – Open Mode Design

Shape & Dimensions



Case	Code	Dimensions (mm)												
JIS	EIA	L	W	Т	В	G								
C2012	CCOOOE	2.00	1.20	0.85	0.00	0.50 min.								
C2012	CC0805	2.00	1.20	1.25	0.20 min.									
				1.15	0.20 min.	1.00 min.								
C3216	CC1206	6 3.20	1.60	1.30										
				1.60										
	CC1210	C1210 3.20	2.50	1.15										
				1.60	0.20 min.	1.00 min.								
C3225				2.00										
												2.30	0.30 min.	
				2.50	0.30 11111.									
	CC1812	2 4.50	3.20	1.60	0.20 min.	2.00 min.								
C4532				2.00										
				2.30										
	CC2220	2220 5.70		1.60		2.00 min.								
C5750			5.00	5.70 5.00 2.00 0.30 min	0.20 min									
C5/50				2.30	0.20 min.									
				2.80										

Inside Structure & Material System



NO.	NO. NAME		MAIERIAL		
		Class 1	Class 2		
(1)	Ceramic Dielectric	CaZrO ₃ BaTiO ₃			
(2)	Internal Electrode	Nicke	cel (Ni)		
(3)		Сорре	er (Cu)		
(4)	Termination	Nickel (Ni)			
(5)		Tin (Sn)			

Environmental Information

TDK Corporation established internal product environmental assurance standards that include the six hazardous substances banned by the EU RoHS Directive¹ enforced on July 1, 2006 along with additional substances independently banned by TDK and has successfully completed making general purpose electronic components conform to the RoHS Directive².

- 1. Abbreviation for Restriction on Hazardous Substances, which refers to the regulation EU Directive 2002/95/EC on hazardous substances by the European Union (EU) effective from July 1, 2006. The Directive bans the use of six specific hazardous substances in electric and electronic devices and products handled within the EU. The six substances are lead, mercury, cadmium, hexavalent chromium, PBB (polybrominated biphenyls), and PBDE (polybrominated diphenyl ethers).
- This means that, in conformity with the EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- For REACH (SVHC: 15 substances according to ECHA / October 2008): All TDK MLCC do not contain these 15 substances.
- For European Directive 2000/53/CE and 2005/673/CE:
 Cadmium, Hexavalent Chromium, Mercury, Lead are not contained in all TDK MLCC.
- For European Directive 2003/11/CE: Pentabromodiphenylether, Octabromodiphenylether are not contained in all TDK MLCC.